HALOGEN

FREE



Vishay General Semiconductor

Surface Mount Schottky Barrier Rectifier



SMA (DO-214AC)

DESIGN SUPPORT TOOLS AVAILABLE



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.5 A			
V_{RRM}	90 V			
I _{FSM}	40 A			
V _F	0.75 V			
T _J max.	150 °C			
Package	SMA (DO-214AC)			
Circuit configuration	Single			

FEATURES

- Low profile package
- Ideal for automated placement
- · Guardring for overvoltage protection
- Low power losses, high efficiency
- Very low switching losses
- High surge capability
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency inverters, switching power supplies, freewheeling diodes, OR-ing diode, DC/DC converters and reverse battery protection.

MECHANICAL DATA

Case: SMA (DO-214AC)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test **Polarity:** color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)					
PARAMETER		SYMBOL	BYS11-90	UNIT	
Device marking code			BYS109		
Maximum repetitive peak reverse voltage		V _{RRM}	90	V	
Maximum average forward rectified current		I _{F(AV)}	1.5	Α	
Peak forward surge current single half sine-wave superimposed on rated load	8.3 ms	ı	40	^	
	10 ms	I _{FSM}	30	A	
Voltage rate of change (rated V _R)		dV/dt	10 000	V/µs	
Junction and storage temperature range		T _J , T _{STG}	-55 to +150	°C	



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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)							
PARAMETER	TEST CONDITIONS		SYMBOL	BYS11-90	UNIT		
Maximum instantaneous forward voltage	1.0 A		1.0 A		V _F ⁽¹⁾	750	mV
Maximum DC reverse current	V	T _J = 25 °C	_P (1)	100	μA		
	V_{RRM}	T _J = 100 °C		1	mA		

Note

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	BYS11-90	UNIT	
Maximum thermal resistance, junction to lead	$R_{\theta JL}$	25	°C/W	
	$R_{\theta JA}$ (1)	150		
Maximum thermal resistance, junction to ambient	$R_{\theta JA}$ (2)	125	°C/W	
		100		

Notes

- (1) Mounted on epoxy-glass hard tissue
- (2) Mounted on epoxy-glass hard tissue, 50 mm² 35 μm Cu
- (3) Mounted on Al-oxide-ceramic (Al₂O₃), 50 mm² 35 μm Cu

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
BYS11-90-M3/TR	0.064	TR	1800	7" diameter plastic tape and reel	
BYS11-90-M3/TR3	0.064	TR3	7500	13" diameter plastic tape and reel	

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

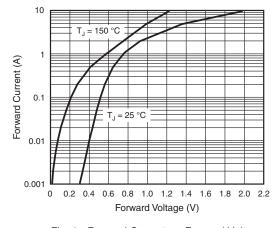


Fig. 1 - Forward Current vs. Forward Voltage

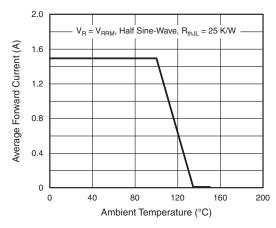


Fig. 2 - Max. Average Forward Current vs. Ambient Temperature



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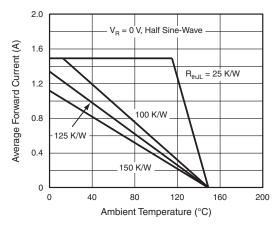


Fig. 3 - Max. Average Forward Current vs. Ambient Temperature

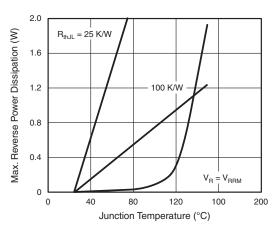


Fig. 5 - Max. Reverse Power Dissipation vs. Junction Temperature

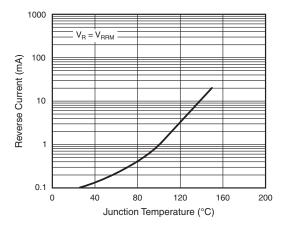


Fig. 4 - Reverse Current vs. Junction Temperature

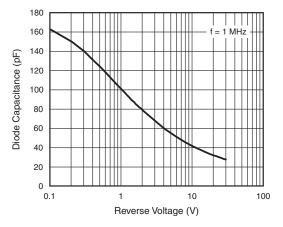
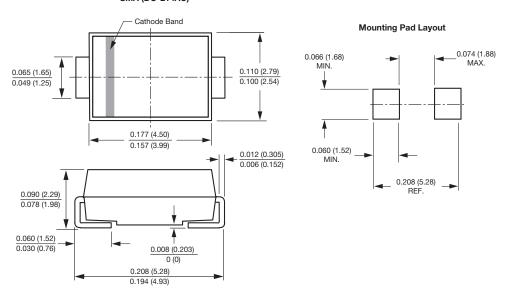


Fig. 6 - Diode Capacitance vs. Reverse Voltage

PACKAGE OUTLINE DIMENSIONS in inches (millimeters) SMA (DO-214AC)



Reivision: 09-May-2019 3 Document Number: 89409

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